

# SMT 2017 BOARD CLEANER

Teknek introduce the "Benchmark" in board cleaning with the SMT2017. World class contact cleaning is achieved within a static controlled environment developed specifically to meet international ESD standards. Increased board processing capability is another innovation in the design of this state of the art product.



## **SPECIFICATION**

TWO CLEANING WIDTHS	40 - 400mm / 40 - 600mm		
OPERATING MODES	Double Side - Bypass or Single Side - Bypass		
ROLLER TYPES AVAILABLE	NT - Nanocleen™ 20.20		
ADHESIVE	Low Static Adhesive Roll		
PROCESSING SPEED	1-40 m/mm		
PASS LINE HEIGHT	900 ± 50mm		
POWER SUPPLY	Universal Power supply		
PNEUMATIC PRESSURE REQUIRED	5-7 bar oil free compressed air		

## **ESD COMPLIANCE**

MACHINE	ANSI / ESDs 20.20 - 2014		
	IEC 61340-5-1:2016		
NANOCLEEN™ 20.20	ANSI / ESDs 6.1 - 2014		
	IEC 61340-5-1:2016		

### **EQUIPMENT GROUNDING COMPLIANCE**

ANNEX A (Automated Handling Equipment)

## **ALL TEKNEK ROLLERS COMPLIANCE**

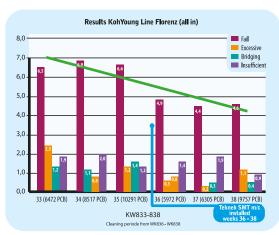
ISO 6123 Class A

## **ALL TEKNEK ADHESIVE ROLLS - COMPLIANCE**

FINAT

#### **SMT DATA**







#### BENEFITS



Rollers & Adhesive

The new NT Rollers and GAR Adhesive are two of the main elements that provide "Low Static Cleaning "at point of cleaning within the SMT2017. A silicone free system is also available in Nanocleen" and GAR adhesive.





Low Static Environment

The new SMT2017 was specifically designed to meet International standard for ESD. A low static Environment has been created through which the bare board is processed.

Static Management was the key innovation, which drove the development of the SMT2017.

#### Compliance:

ANSI / ESDs 20.20 - 2014 & ANSI / ESDs 6.1 - 2014 IEC 61340-5-1:2016



Follow Me

To increase up-time of the SMT2017, Teknek have developed an independent automatic conveyor width adjustment system. The moving rail within the machine automatically follows the width change of the conveyor before or after, ensuring production up-time is maximized.



Increased Capability

The introduction of a continuous Rail system on the Single side SMT2017 increases board processing capabilities. Boards at 50x50mm - 600x600mm can be smoothly processed and cleaned through this machine.

The new rail design & light weight roller technology provide Low Applied Pressure to the surface of the board. NO damage to embedded circuits & components.



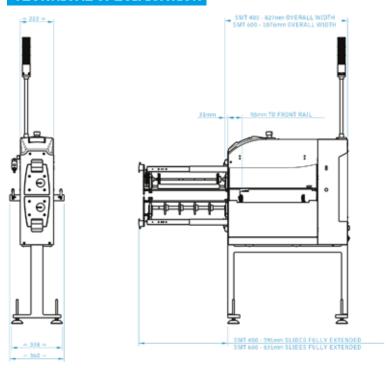
New Operator interface

Teknek has incorporated a new, faster PLC from ProFace. This easy to use, multi lingual touchscreen ensure minimal training is required to setup and operate the SMT2017.

The new software has the ability to store 250 different board programs making change over quick & easy.

# SMT 2017 BOARD CLEANER

## **TECHNICAL SPECIFICATION**



teknek

An ITW Company

Note: Customer can fit Low Static Adhesive Rolls to the SMT2017

## **CAPABILITY**

BOARD PROCESSING			
DOUBLE SIDE CLEANING	Min - Max Length	98mm - N/A	98mm - N/A
	Min - Max Width	40mm - 400mm	40mm - 600mm
	Min - Max Thickness	0.6mm - 3.2mm	0.6mm - 3.2mm
BY-PASS NO CLEANING	Min - Max Length	120mm - N/A	120mm - N/A
	Min - Max Width	40mm - 400mm	40mm - 600mm
	Min - Max Thickness	0.6mm - 3.2mm	0.6mm - 3.2mm
SINGLE SIDE CLEANING	Min - Max Length	50mm - N/A	50mm - N/A
	Min - Max Width	40mm - 400mm	40mm - 600mm
	Min - Max Thickness	0.6mm - 3.2mm	0.6mm - 3.2mm
BY-PASS NO CLEANING	Min - Max Length	50mm - N/A	50mm - N/A
	Min - Max Width	40mm - 400mm	40mm - 600mm
	Min - Max Thickness	0.6mm - 3.2mm	0.6mm - 3.2mm



#### **WORLD LEADER IN CONTACT CLEANING**

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